

# CGHV40180P

180 W, DC - 2.0 GHz, 50 V, GaN HEMT

## **Description**

The CGHV40180P is an unmatched, gallium nitride (GaN) high electron mobility transistor (HEMT). The CGHV40180P, operating from a 50 volt rail, offers a general purpose, broadband solution to a variety of RF and microwave applications. GaN HEMTs offer high efficiency, high gain, and wide bandwidth capabilities making the CGHV40180P ideal for linear and compressed amplifier circuits. The transistor is available in a 2-lead pill package.



Package Types: 440206 PN's: CGHV40180P

#### **Features**

- Up to 2.0 GHz operation
- 24 dB small signal gain at 900 MHz
- 20 dB power gain at 900 MHz
- 250 W typical output power at 900 MHz
- 75% efficiency at P<sub>SAT</sub>

## **Applications**

- Military communications
- Public safety VHF-UHF applications
- Radar
- Medical
- Broadband amplifiers

## Typical Performance Over 800 MHz - 1000 MHz ( $T_c = 25$ °C), 50 V

Parameter	800 MHz	850 MHz	900 MHz	950 MHz	1000 MHz	Units
Small Signal Gain	25.6	25.2	24.6	24.4	24.3	dB
Gain @ P <sub>IN</sub> 34 dBm	20.4	20.8	20.4	20.1	20.1	dB
Output Power @ P <sub>IN</sub> 34 dBm	275	302	275	257	257	W
EFF @ P <sub>IN</sub> 34 dBm	67	75	76	73	71	%

Note

Measured CW in the CGHV40180P-AMP Application circuit.







## Absolute Maximum Ratings (Not Simultaneous) at 25 °C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V <sub>DSS</sub>	150	Volts	25 °C
Gate-to-Source Voltage	V <sub>GS</sub>	-10, +2	Volts	25 °C
Storage Temperature	T <sub>STG</sub>	-65, +150	°C	
Operating Junction Temperature <sup>1</sup>	T <sub>J</sub>	225	°C	
Maximum Forward Gate Current	I <sub>GMAX</sub>	42	mA	25 °C
Maximum Drain Current <sup>1</sup>	I <sub>DMAX</sub>	12.1	А	25 °C
Soldering Temperature <sup>2</sup>	T <sub>s</sub>	245	°C	
CGHV40180P Thermal Resistance, Junction to Case	R <sub>eJC</sub>	0.87	°C/W	P <sub>DISS</sub> = 150, 85 °C
Maximum Dissipated Power		150	W	P <sub>DISS</sub> = 150, 85 °C
Case Operating Temperature <sup>3</sup>	T <sub>c</sub>	-40, +150	°C	

#### Notes:

#### **Electrical Characteristics**

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
DC Characteristics¹(T <sub>c</sub> = 25 °C)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-3.8	-3.0	-2.3	V <sub>DC</sub>	$V_{DS} = 10 \text{ V}, I_{D} = 41.8 \text{ mA}$
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V <sub>DC</sub>	$V_{DS} = 50 \text{ V}, I_{D} = 1000 \text{ mA}$
Saturated Drain Current <sup>2</sup>	I <sub>DS</sub>	31.4	37.6	-	Α	$V_{DS} = 6.0 \text{ V}, V_{GS} = 2.0 \text{ V}$
Drain-Source Breakdown Voltage	V <sub>BR</sub>	125	-	-	V <sub>DC</sub>	$V_{GS} = -8 \text{ V}, I_{D} = 41.8 \text{ mA}$
RF Characteristics $^3$ (T <sub>c</sub> = 25 °C, F <sub>0</sub> = 90		s Otherwi	se Noted)			
Small Signal Gain	G <sub>ss</sub>	22.8	24.0	-	dB	$V_{DD} = 50 \text{ V}, I_{DQ} = 1.0 \text{ A}, P_{in} = 10 \text{ dBm CW}$
Power Gain	G <sub>P</sub>	18.4	19.8	ı	dB	$V_{DD} = 50 \text{ V}, I_{DQ} = 1.0 \text{ A}, P_{in} = 34 \text{ dBm CW}$
Power Output at Saturation	Роит	52.6	53.9	-	dBm	$V_{DD} = 50 \text{ V}, I_{DQ} = 1.0 \text{ A}, P_{in} = 34 \text{ dBm CW}$
Drain Efficiency⁴	η	59	69	-	%	$V_{DD} = 50 \text{ V}, I_{DQ} = 1.0 \text{ A}, P_{in} = 34 \text{ dBm CW}$
Output Mismatch Stress	VSWR	-	-	3:1	Ψ	No Damage at All Phase Angles, $V_{DD} = 50 \text{ V}, I_{DQ} = 1.0 \text{ A}, P_{OUT} = 180 \text{ W CW}$
Dynamic Characteristics						
Input Capacitance	C <sub>GS</sub>	-	57.8	-	pF	$V_{DS} = 50 \text{ V}, V_{GS} = -8 \text{ V}, f = 1 \text{ MHz}$
Output Capacitance	C <sub>DS</sub>	-	13.7	-	pF	$V_{DS} = 50 \text{ V}, V_{GS} = -8 \text{ V}, f = 1 \text{ MHz}$
Feedback Capacitance	C <sub>GD</sub>	-	1.23	_	pF	$V_{DS} = 50 \text{ V}, V_{GS} = -8 \text{ V}, f = 1 \text{ MHz}$

<sup>&</sup>lt;sup>1</sup> Current limit for long term, reliable operation.

<sup>&</sup>lt;sup>2</sup> Refer to the Application Note on soldering.

<sup>&</sup>lt;sup>3</sup> See also, power de-rating curve on page 5.

 $<sup>^{\</sup>scriptscriptstyle 1}\,\text{Measured}$  on wafer prior to packaging.

<sup>&</sup>lt;sup>2</sup> Scaled from PCM data.

 $<sup>^{\</sup>rm 3}$  Measurements are to be performed using the production test fixture AD-838292P-TB.

<sup>&</sup>lt;sup>4</sup> Drain efficiency =  $P_{OUT}/P_{DC}$ .



#### **CGHV40180P Typical Performance**

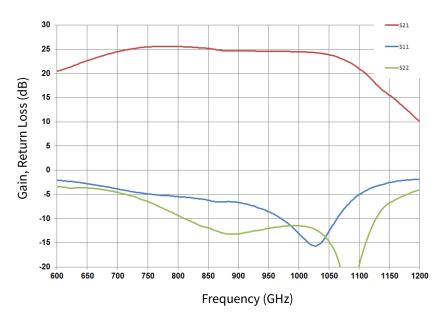


Figure 1. Small Signal Gain and Return Loss vs Frequency Measured in Application Circuit CGHV40180P  $\rm V_{DD}$  = 50 V,  $\rm I_{DQ}$  = 1.0 A

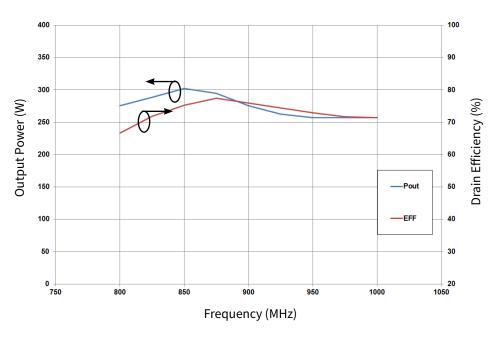


Figure 2. Output Power and Drain Efficiency vs Frequency CGHV40180P-TB, CW Operation,  $V_{DD}$  = 50 V,  $I_{DQ}$  = 1.0 A, @  $P_{IN}$  34 dBm



## **CGHV40180P Typical Performance**

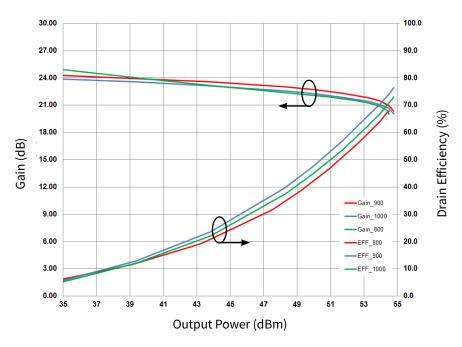


Figure 3. Gain and Drain EFF vs Frequency and Output Power CGHV40180P-TB, CW Operation,  $V_{DD} = 50 \text{ V}$ ,  $I_{DQ} = 1.0 \text{ A}$ 

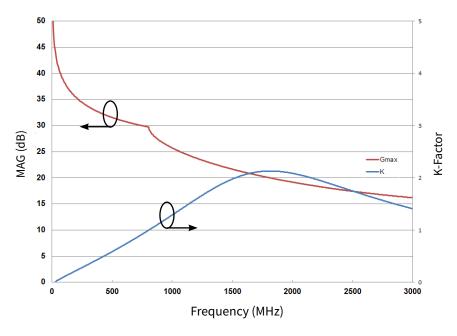


Figure 4. Simulated Maximum Available Gain and K-factor of the CGHV40180P  $\rm V_{DD}$  = 50 V,  $\rm I_{DQ}$  = 1.0 A



## **CGHV40180P Power Dissipation De-Rating Curve**

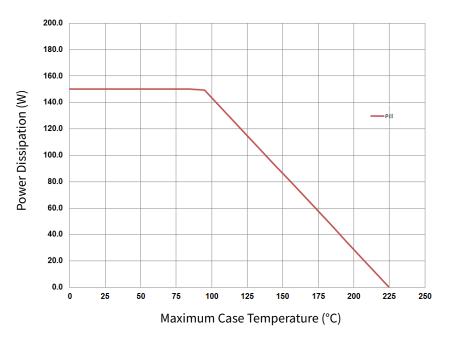
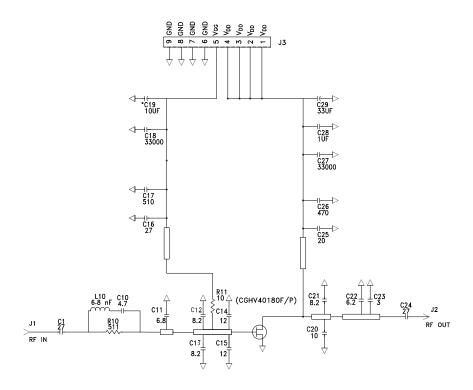


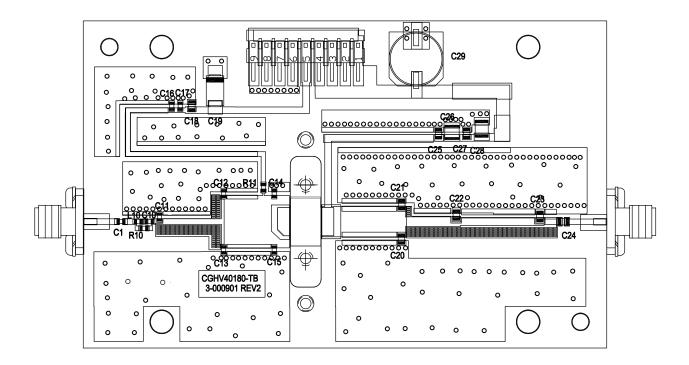
Figure 5. Transient Power Dissipation De-Rating Curve



#### **CGHV40180P-AMP Application Circuit Schematic**



#### **CGHV40180P-AMP Application Circuit**





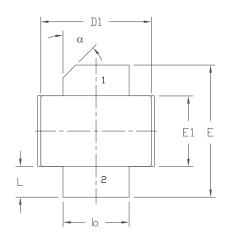
## **CGHV40180P-AMP Application Circuit Bill of Materials**

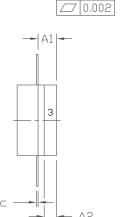
Designator	Description	Qty
R11	RES, 1/16 W, 0603, 1%, 10.0 OHMS	1
R10	RES, 1/16 W, 0603, 1%, 511 OHMS	1
C29	CAP, 33 UF, 20%, G CASE	1
C28	CAP 1.0 UF, 100 V, ±10%, X7R, 1210	1
C17	CAP, 510 pF, NPO, 5%, 100 V, 0603	1
C26	CAP, 470 pF, NPO, 5%, 250 V, ATC800B	1
C19	CAP, 10 UF, 16 V TANTALUM, 2312	1
C14, C15	CAP, 12.0 pF, ±5%, 0603, ATC600S	2
C1, C16	CAP, 27 pF, ±5%, 0603, ATC600S	2
C10	CAP, 4.7 pF, ±0.1 pF, 0603, ATC600S	1
C11	CAP, 6.8 pF, ±0.25 pF, 0603, ATC600S	1
C12, C13	CAP, 8.2 pF, ±0.25 pF, 0603, ATC600S	2
C18, C27	CAP, 33000 pF, 0805, 100 V, X7R	2
C20	CAP, 10 pF, ±1%, 250 V, 0805, ATC600F	2
C25	CAP, 20 pF, ±5%, 250 V, 0805, ATC600F	1
C24	CAP, 27 pF, ±5%, 250 V, 0805, ATC600F	1
C23	CAP, 3.0 pF, ±0.1pF, 250 V, 0805, ATC600F	2
C22	CAP, 6.2 pF, ±0.1 pF, 250 V, 0805, ATC600F	1
C21	CAP, 8.2 pF, ±0.1 pF, 250 V, 0805 ATC600F	1
-	PCB ROGERS HTC6035, 0.020 THK, ER 3.60	1
J1, J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4 HOLE BLUNT POST	2
J3	HEADER RT>PLZ .1 CEN LK 9 POS	1
L10	INDUCTOR, CHIP, 6.8 nH, 5%, 0603 SMT, DIGIKEY 712-1432-1-ND	1
Q1	CGHV40180	1

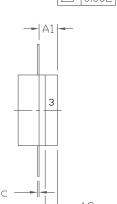


#### Product Dimensions CGHV40180P (Package Type — 440206)

Α







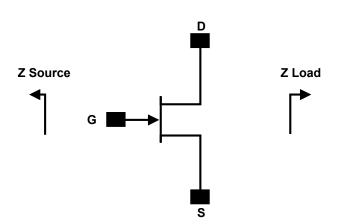
#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M 1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
- 4, LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008' IN ANY DIRECTION.

	INCHES		MILLIMETERS		NOTES
DIM	MIN	MAX	MIN	MAX	
Α	0.125	0.145	3.18	3.68	
A1	0.057	0.067	1.45	1.70	
A2	0.035	0.045	0.89	1.14	
b	0.210	0.220	5.33	5.59	2x
С	0.004	0.006	0.10	0.15	2x
D	0.375	0.385	9.53	9.78	
D1	0.355	0.365	9.02	9.27	
E	0.400	0.460	10.16	11.68	
E1	0.225	0.235	5.72	5.97	
L	0.085	0.115	2.16	2.92	2×
α	45° REF		45°	REF	

- PIN 1. GATE
  - 2. DRAIN
  - 3. SOURCE

#### **Source and Load Impedances**



Frequency (MHz)	Z Source	Z Load
50	23.7 + J25.9	7.6 + J0.6
150	7.4 + J8.3	8.1 + J0.7
250	4.2 +J7.9	7.9 + J2.2
500	1.4 + J1.5	4.7 + J2.7
750	1.0 + J0.0	3.9 + J2.3
1000	0.7 + J1.1	4.0 + J1.8

- $^1\,\rm V_{DD}^{}$  = 50 V,  $\rm I_{DQ}^{}$  = 1.0 A in the 440206 package.
- <sup>2</sup> Optimized for power gain, P<sub>SAT</sub> and drain efficiency.
- <sup>3</sup> When using this device at low frequency, series resistor should be used to maintain amplifier stability.

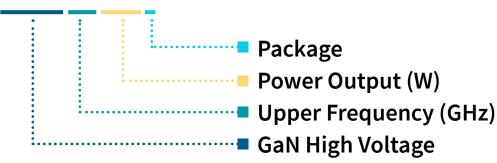
#### **Electrostatic Discharge (ESD) Classifications**

Parameter	Symbol	Class	Test Methodology
Human Body Model	НВМ	1 A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	2 (125 V to 250 V)	JEDEC JESD22 C101-C



#### **Part Number System**

## **CGHV40180P**



#### Table 1.

Parameter	Value	Units
Upper Frequency <sup>1</sup>	4.0	GHz
Power Output	180	W
Package	Flange	-

Note

#### Table 2.

Character Code	Code Value
A	0
В	1
С	2
D	3
E	4
F	5
G	6
Н	7
J	8
К	9
Examples:	1 A = 10.0 GHz 2 H = 27.0 GHz

 $<sup>^{\</sup>rm 1}$  Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.



## **Product Ordering Information**

Order Number	Description	Unit of Measure	Image
CGHV40180P	GaN HEMT	Each	CEHNAO1808
CGHV40180P-AMP	Test Board with GaN HEMT (Pill) Installed	Each	



#### Notes & Disclaimer

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